## CSE 331/503

## Computer Organization

## Homework 1

Wafer area = 
$$\Pi R^2 = 3$$
,  $14 \times \left(\frac{16}{2}\right)^2 = 3$ ,  $14 \times 64 = [200, 96 \text{ cm}^2]$   
Die area =  $\frac{\text{Wafer area}}{\text{Dies per wafer}} = \frac{200, 96}{64} = [3, 14 \text{ cm}^2]$ 

Wafer Y

Wafer area = 
$$\pi R^2 = 3.14 \times (\frac{20}{2})^2 = 3.14 \times 100 = 314 \text{ cm}^2$$
  
Die area =  $\frac{314}{100} = 3.14 \text{ cm}^2$ 

B) Wafer\_X

Wafer\_4

$$\frac{1}{(1+(0.03\times3.14/2))^2}=[0.91]$$

Cost per die = 
$$\frac{24}{100 \times 0.91} = 0.26$$

## C) Wafer X

$$Vield = \frac{1}{(1 + (0.023 \times 2.85/2))^2} = 0.9375$$

$$(1 + (0.023 \times 2.85 /2))^{2}$$
Cost per die =  $\frac{12}{70.4 \times 0.9375}$  =  $[0.18] < [0.25] \rightarrow Last year's cost$ 

Defect 
$$/cm^2 = 0.03 \times 1.15 = 0.0345$$

$$Vield = \frac{1}{(1 + (0.0345 \times 2.8545/2))^2} = [0.9083]$$

Cost per die = 
$$\frac{19.2}{110 \times 0.9083}$$
 = 0,19 < 0,26 > Last year's cost

2. A) P1

$$= \underbrace{10^{9} \times 0.3 \times 2}_{\text{R type}} + \underbrace{10^{9} \times 0.5 \times 4}_{\text{I type}} + \underbrace{10^{9} \times 0.2 \times 3}_{\text{J type}}$$

$$= 0.6 \times 10^9 + 2 \times 10^9 + 0.6 \times 10^9 = [3,2 \times 10^9]$$

P 2

Clock cycle = 
$$10^9 \times 9.3 \times 3 + 10^9 \times 0.5 \times 3 + 10^9 \times 0.2 \times 3$$
  
=  $3 \times 10^9$ 

B) 
$$2 \times 0.3 + 4 \times 0.5 + 3 \times 0.2 = 3.2$$
 (P1)

$$3 \times 0.3 + 3 \times 0.5 + 3 \times 0.2 = 3$$
 (P2)

C) CPU time = CPU clock cycles / clock rate

(P1) 
$$\frac{3.2 \times 10^{5}}{3 \times 10^{5}} = 1,07$$
 sec.

$$\frac{3 \times 10^8}{1.5 \times 10^8} = 2 \text{ sec.}$$

$$\frac{2}{1,07} = 1,87$$

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